				OP	ERATIN	G CHARACTERIS	TICS AT 25° C	AMBIENT		
LUMINOUS COLOR	FORWARD VOLTAGE (V) @ I _F = 20 mA		LUMINOUS INTENSITY (mcd) @ I _F = 20 mA		PEAK WAVELENGTH (nm)	DOMINANT WAVELENGTH (nm)	VIEWING ANGLE (DEGREES)	LUMINOUS EFFICACY (Im/w)	LUMINOUS INTENSITY/ TOTAL FLUX Iv(mcd)/\psi(mlm)	
	TYP	MAX	MIN.	TYP.	MAX.	TYP.	TYP.	TYP.	TYP.	TYP.
RED	2.2	2.6	112.50	140.00		639	630	120	155	0.45

ABSOLUTE MAXIMUM RATINGS AT 25° C AMBIENT	RED	UNITS
POWER DISSIPATION	72	mW
PEAK FORWARD CURRENT (DUTY FACTOR = 10%, FREQUENCY = 1 kHz)	100	m A
DC FORWARD CURRENT	30	mΑ
DERATE LINEARLY FROM 40°C	0.42	mA/°C
REVERSE VOLTAGE	5	٧
JUNCTION TEMPERATURE	+ 0	°C
STORAGE TEMPERATURE	-55 TO +100	°C
OPERATING TEMPERATURE	-55 TO +100	°C
I.R. REFLOW SOLDERING TEMPERATURE, 20 SEC. MAX.	240	°C

TEMPERATURE ──►	217 °C 255 °C (+5/-0) 3 °C/SEC. MAX. 100 - 150 °C MAX. 120 SEC. 60 to 150 SEC.
	TIME ——

COUNTRY OF ORIGIN

REVISIONS

NEW RELEASE

DRN. CKD. APP.

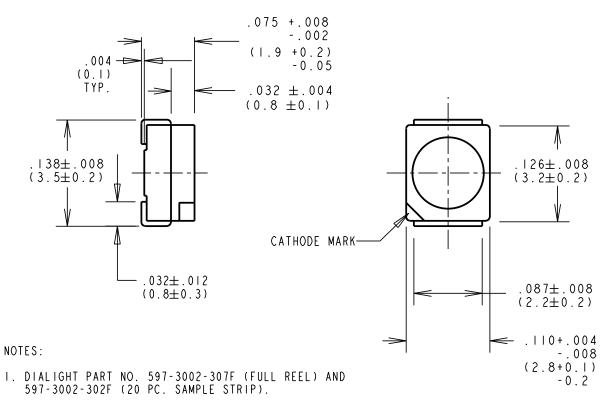
TC

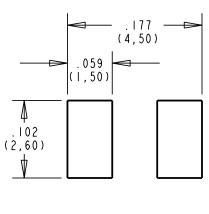
DATE

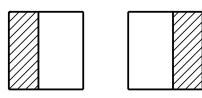
REV. ECN NO.

FIGURE (I)

RoHS COMPLIANT REFLOW SOLDERING PROFILE

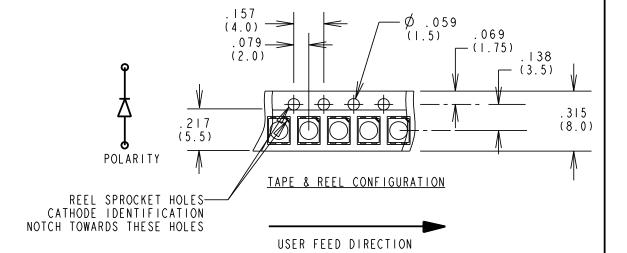








RECOMMENDED SOLDERING PAD PATTERN



RoHS Compliant 597-3002-30XF

Part Numbers with the "F" suffix ending are RoHS Compliant. Example: 597-3002-302F
Packaging is marked with "RoHS Compliant" label or equivalent markings.
Parts can be wave soldered, dip soldered or hand soldered using typical lead-free soldering process with max 260°C temp. for 5 sec.

83330

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SCALE: NONE
ALL DIM'S IN: INCHES (MM)
TOLERANCES: UNLESS OTHERWISE SPECIFIED
FRACTIONS: ±1/64
DECIMALS (.XXX): ±.01
DECIMALS (.XXX): ±.005
DECIMALS (.XXXX): ±.005
DECIMALS (.XXXX): ±.005

MATERIAL

SHEET

1501 ROUTE 34 SOUTH

FAMILY TABLE:

FARMINGDALE, NJ 07727

FRACTIONS: ±
DECIMALS (.)
DECIMALS (.)
DECIMALS (.)
DECIMALS (.)
ANGLES: ±1°
FINISH:

FSCM

ATTENTION:

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES

- 2. DIE: TS AllnGaP RED
- 3. SOLDER ADHERANCE: EACH PAD PER MIL-STD-202E, METHOD 208C. TERMINAL FINISH PURE TIN(Sn) OVER COPPER ALLOY(Cu).
- 4. TAPE AND REEL AS PER EIA STANDARD 481-1, WITH CATHODE TOWARD SPROCKET.
- 5. PACKAGE ON 180 mm DIA REEL, 8 mm TAPE, 2000/REEL. PACKAGING TO INCLUDE: DIALIGHT LABEL (SEE FIGURE I) WITH CATALOG P/N, LED P/N OPTIONAL, DATE CODE/LOT NO., LUMINOUS INTENSITY RANK AND COLOR BIN CLASSIFICATION, QTY / REEL, AND COUNTRY OF ORIGIN. LABEL BOTH REEL AND SEALED ALUMINUM VAPOR BARRIER BAG WITH DESICCANT INSIDE. PARTS POSITIONED WITH 4 mm PITCH ON REELS.
- 6. ALUMINUM MOISTURE BARRIER BAG TO HAVE A MOISTURE SENSITIVITY LEVEL "2α" LABEL APPLIED AS PER JEDEC STD. 033
- 7. TAPE AND REEL LEDS MAY REQUIRE RE-TAPING AFTER TWELVE MONTHS